

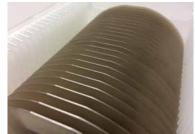


DW 288 S4 SLURRY









PRECISION AND STABILITY WITH SLURRY TECHNOLOGY

- Optimized cutting fluid management for slurry
- Best in class for SiC and 8" semiconductor industry
- Versatile applications for different formats

SLURRY SLICING TECHNOLOGY FOR SILICON CARBIDE AND HART MATERIALS



HIGHLIGHTS DW 288 S4 SLURRY

- Based on widely adopted and successful DW 288 product family
- Sophisticated work piece rocking for maximum precision
- Only 6 pulleys for optimal use of diamond wire
- Application and material dependent options available
- Process driven production assistant on touch screen HMI
- Recipe generator for 60-step recipe
- Ready for Industry 4.0
- Options: Adaptive feed for optimized cutting process







Optimized cutting fluid system for lower downtime



Easy accessibility for higher uptime

TECHNICAL DATA	DW 288 S4 SLURRY FEATURES
Web length [mm]	420
Max. work piece dimensions [mm]	Ø 206 (optional Ø 230) × 420
Wire speed [m/s]	25 (1500 m/min)
Min. wire diameter [µm]	100
Max. wire tension [N]	45
Rocking principle	Rocking of work piece
Rocking angle [°]	±12
Wire guide roller axis distance [mm]	540
Cutting fluid tank [I]	240
Machine dimensions [L×W×H] [mm]	3620×1780×3010
Machine weight [kg]	10500

GET IN TOUCH WITH US TODAY

TOGETHER WE WILL FIND A SOLUTION FOR YOUR REQUIREMENTS

LAPMASTER WOLTERS GMBH

Phone: +49 4331 458 0 slicing@lapmaster-wolters.de www.lapmaster-wolters.de